

Features

- Excellent $R_{DS(ON)}$ and Low Gate Charge
- 100% UIS Tested
- 100% ΔV_{ds} Tested
- Halogen-free; RoHS-compliant

Applications

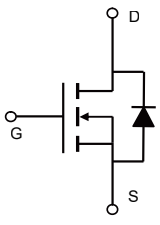
- Load Switch
- PWM Application
- Power Management

Product Summary

Parameters	Value	Unit
V_{DSS}	150	V
$V_{GS(th_Typ)}$	3.1	V
$I_D(@V_{GS}=10V)$	84	A
$R_{DS(ON_Typ)}(@V_{GS}=10V)$	8.1	$m\Omega$



TO-263



Schematic

Ordering Information

Device	Marking	MSL	Form	Package	Reel(pcs)	Per Carton (pcs)
VSM84N15-T3	VSM84N15	3	Tape&Reel	TO-263	800	4000

Absolute Maximum Ratings (@ $T_C = 25^{\circ}C$ unless otherwise specified)

Symbol	Parameter	Value	Unit
V_{DS}	Drain-to-Source Voltage	150	V
V_{GS}	Gate-to-Source Voltage	± 20	V
I_D	Continuous Drain Current	$T_C = 25^{\circ}C$ $T_C = 100^{\circ}C$	A
I_{DM}	Pulsed Drain Current ⁽¹⁾	Refer to Fig.4	A
E_{AS}	Single Pulsed Avalanche Energy ⁽²⁾	536	mJ
P_D	Power Dissipation	$T_C = 25^{\circ}C$ $T_C = 100^{\circ}C$	W
T_J, T_{STG}	Junction & Storage Temperature Range	-55 to 150	$^{\circ}C$

Thermal Characteristics

Symbol	Parameter	Max	Unit
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient ⁽³⁾	28	$^{\circ}C/W$
$R_{\theta JC}$	Thermal Resistance, Junction to Case	0.7	

Electrical Characteristics (T_J = 25°C unless otherwise specified)

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
Off Characteristics						
V _{(BR)DSS}	Drain-Source Breakdown Voltage	I _D = 250 μA, V _{GS} = 0V	150	-	-	V
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} = 120V, V _{GS} = 0V	-	-	1.0	μA
I _{GSS}	Gate-Body Leakage Current	V _{DS} = 0V, V _{GS} = ±20V	-	-	±100	nA
On Characteristics						
V _{GS(th)}	Gate Threshold Voltage	V _{DS} = V _{GS} , I _D = 250 μA	2.2	3.1	4.0	V
R _{DS(ON)}	Static Drain-Source ON-Resistance ⁽⁴⁾	V _{GS} = 10V, I _D = 20A	-	8.1	10.5	mΩ
Dynamic Characteristics						
R _g	Gate Resistance	f = 1MHz	-	3.7	-	Ω
C _{iSS}	Input Capacitance	V _{GS} = 0V, V _{DS} = 75V, f = 1MHz	2549	3569	4818	pF
C _{oSS}	Output Capacitance		231	323	436	pF
C _{rSS}	Reverse Transfer Capacitance		10	14	19	pF
Q _g	Total Gate Charge	V _{GS} = 0 to 10V V _{DS} = 75V, I _D = 20A	38	53	71	nC
Q _{gs}	Gate Source Charge		13	19	25	nC
Q _{gd}	Gate Drain("Miller") Charge		9	12	17	nC
Switching Characteristics						
t _{d(on)}	Turn-On DelayTime	V _{GS} = 10V, V _{DD} = 75V I _D = 20A, R _{GEN} = 3 Ω	-	16	-	ns
t _r	Turn-On Rise Time		-	29	-	ns
t _{d(off)}	Turn-Off DelayTime		-	39	-	ns
t _f	Turn-Off Fall Time		-	16	-	ns
Body Diode Characteristics						
I _S	Maximum Continuous Body Diode Forward Current		-	-	84	A
I _{SM}	Maximum Pulsed Body Diode Forward Current		-	-	336	A
V _{SD}	Body Diode Forward Voltage	V _{GS} = 0V, I _S = 20A	-		1.2	V
trr	Body Diode Reverse Recovery Time	I _F = 15A, di/dt = 100A/us	-	85	-	ns
Qrr	Body Diode Reverse Recovery Charge		-	253	-	nC

- Notes:
1. Repetitive Rating: Pulse Width Limited by Maximum Junction Temperature.

2. E_{AS} condition: Starting T_J=25C, V_{DD}=75V, V_{GS}=10V, R_G=25ohm, L=3mH, I_{AS}=18.9A, V_{DD}=0V during time in avalanche.

3. R_{θJA} is measured with the device mounted on a 1inch² pad of 2oz copper FR4 PCB.

4. Pulse Test: Pulse Width≤300μs, Duty Cycle≤0.5%.

Typical Performance Characteristics

Figure 1: Power De-rating

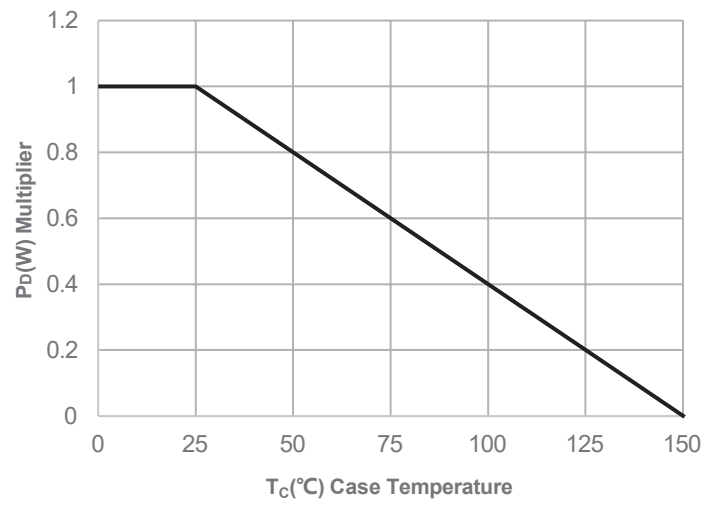


Figure 2: Current De-rating

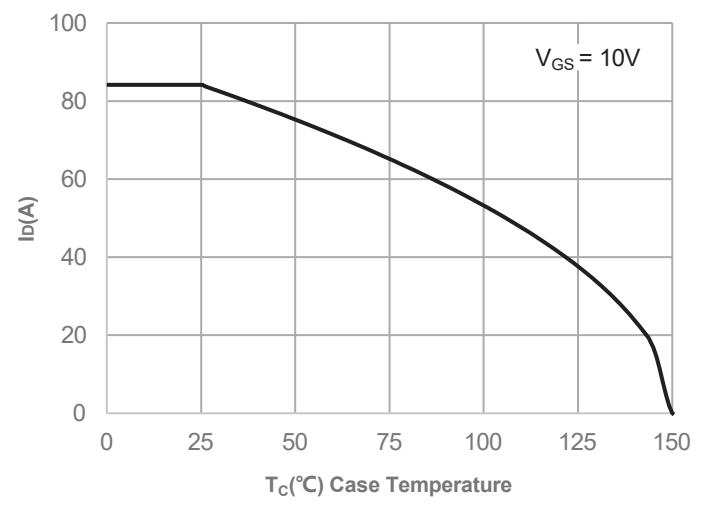


Figure 3: Normalized Maximum Transient Thermal Impedance

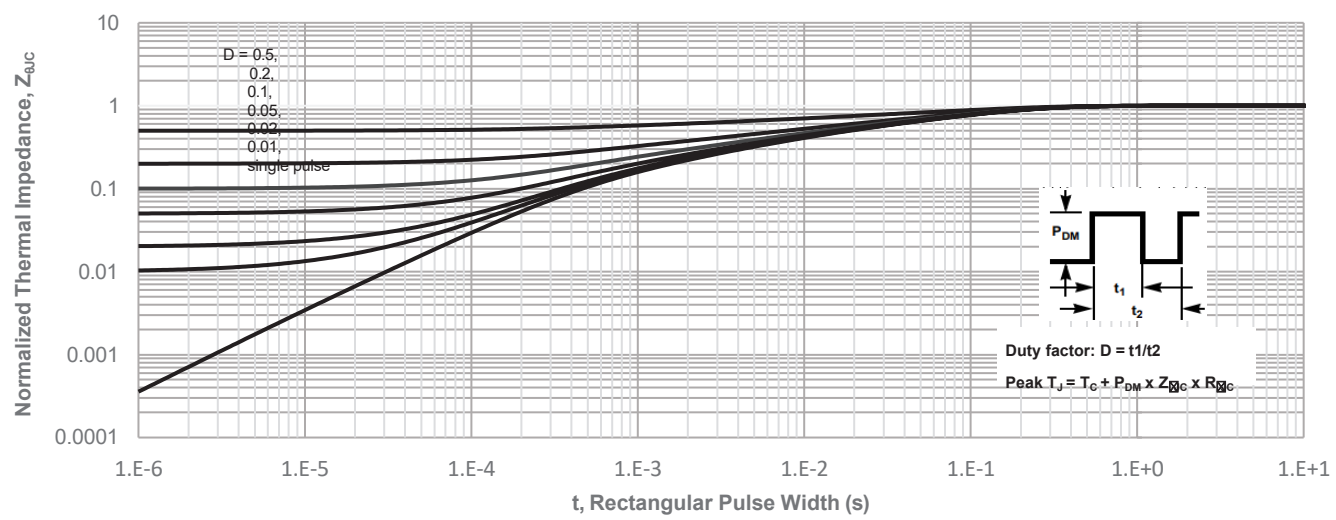
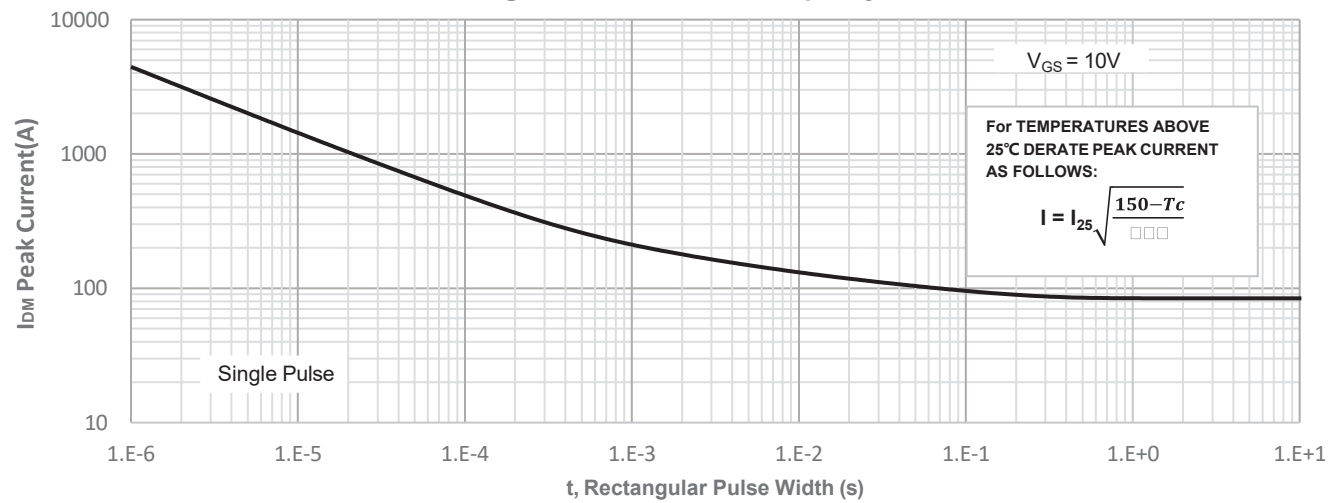
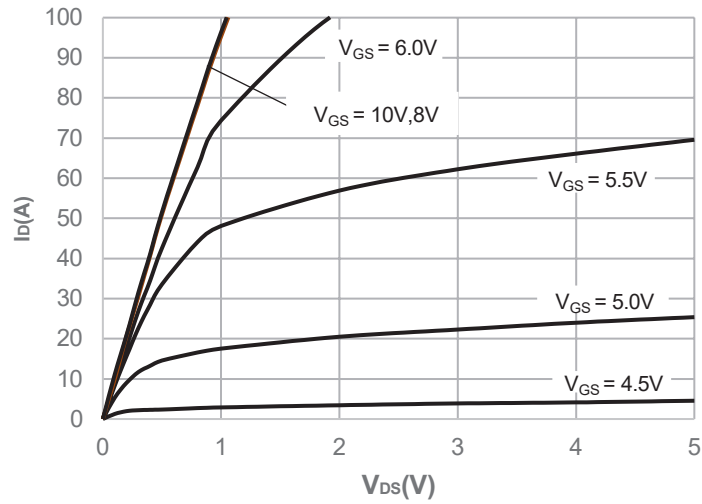
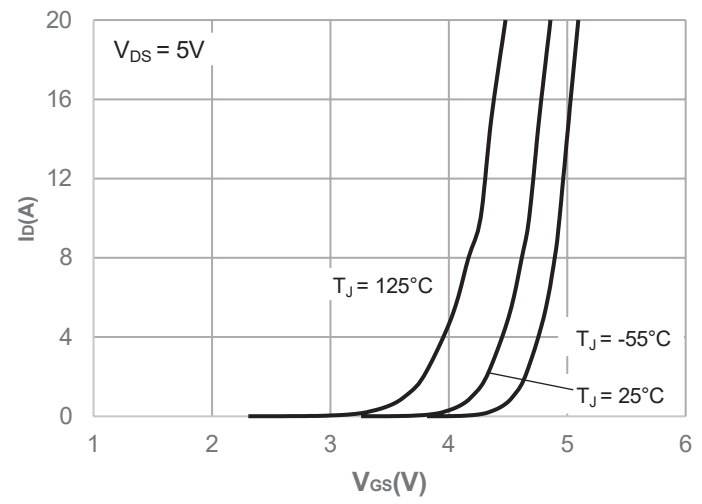
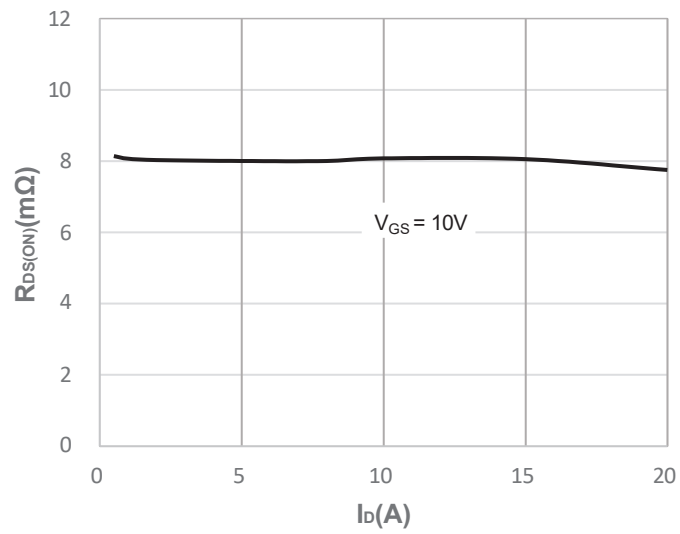
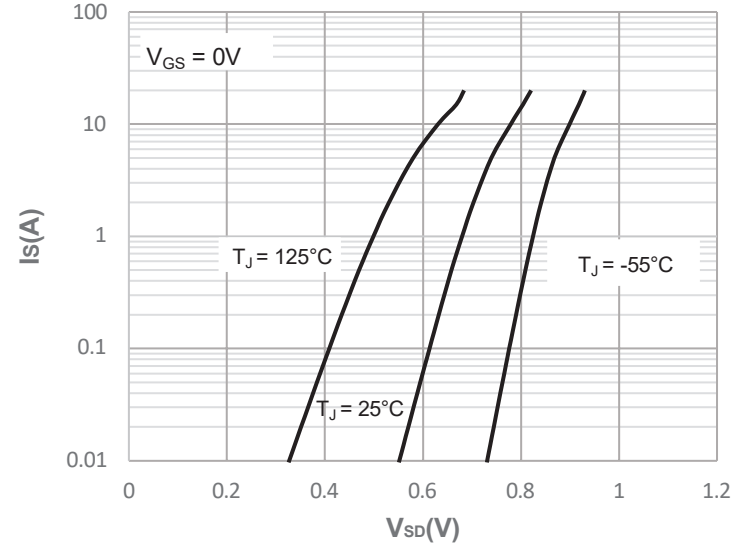
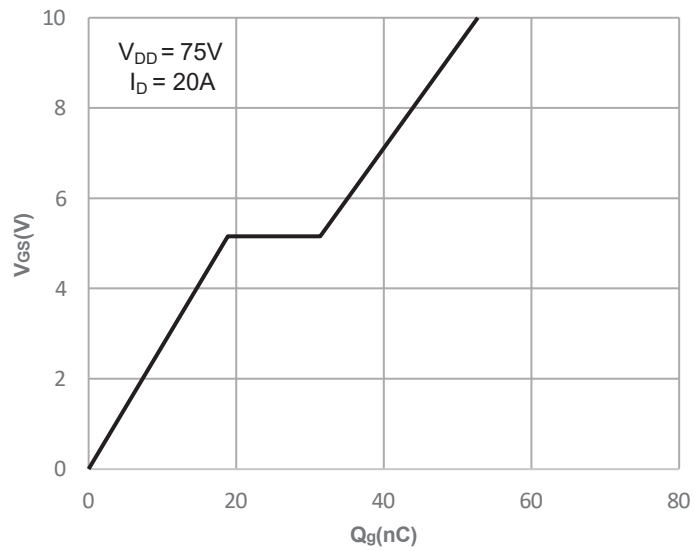
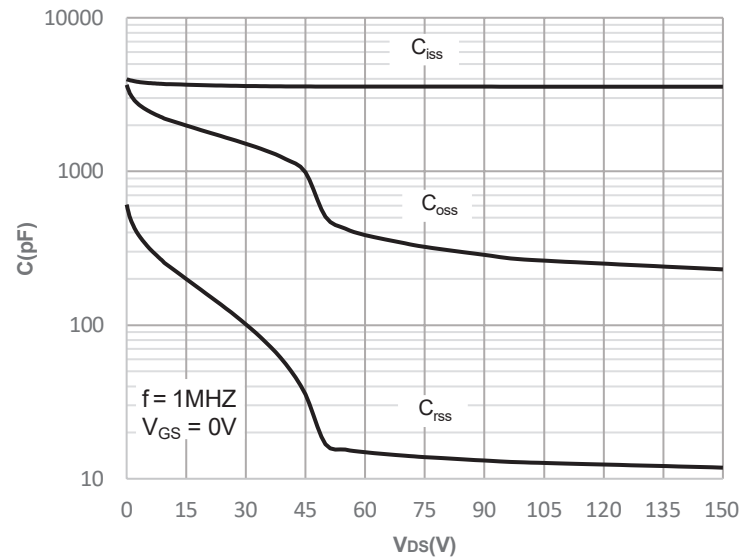


Figure 4: Peak Current Capacity



Typical Performance Characteristics

Figure 5: Output Characteristics

Figure 6: Typical Transfer Characteristics

Figure 7: On-resistance vs. Drain Current

Figure 8: Body Diode Characteristics

Figure 9: Gate Charge Characteristics

Figure 10: Capacitance Characteristics


Typical Performance Characteristics

Figure 11: Normalized Breakdown voltage vs. Junction Temperature

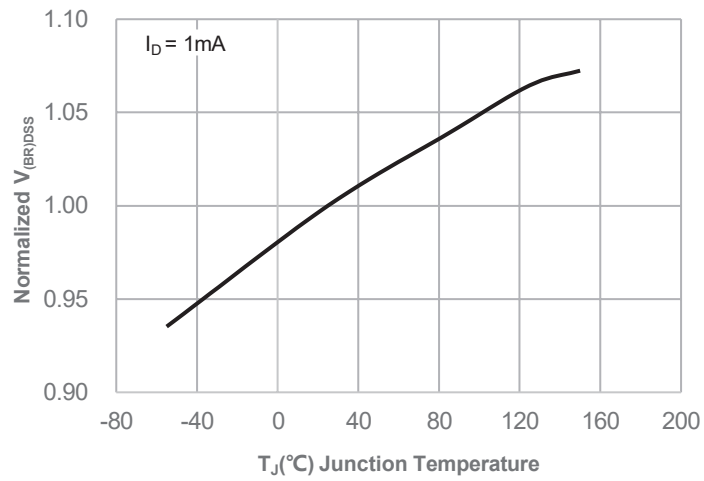


Figure 12: Normalized on Resistance vs. Junction Temperature

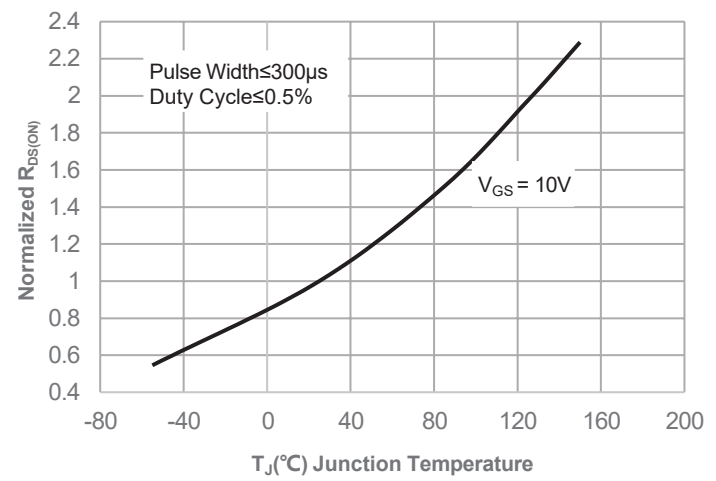


Figure 13: Normalized Threshold Voltage vs. Junction Temperature

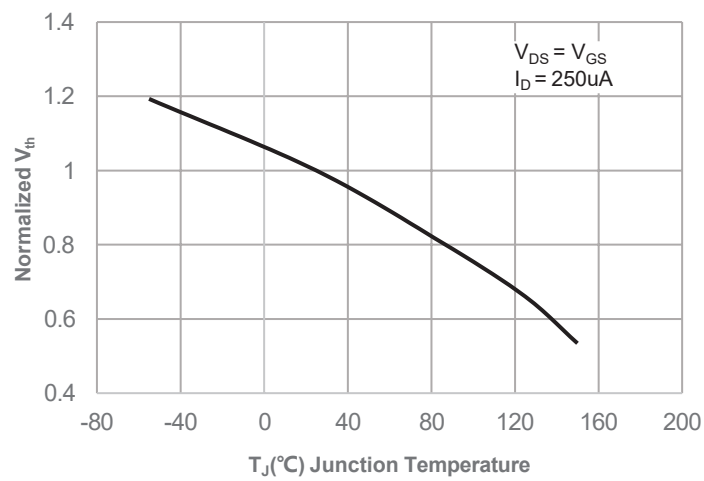


Figure 14: RDS(ON) vs. VGS

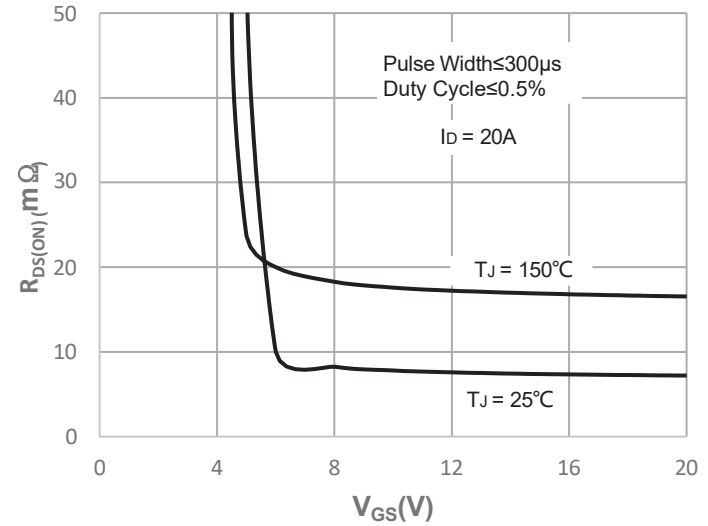
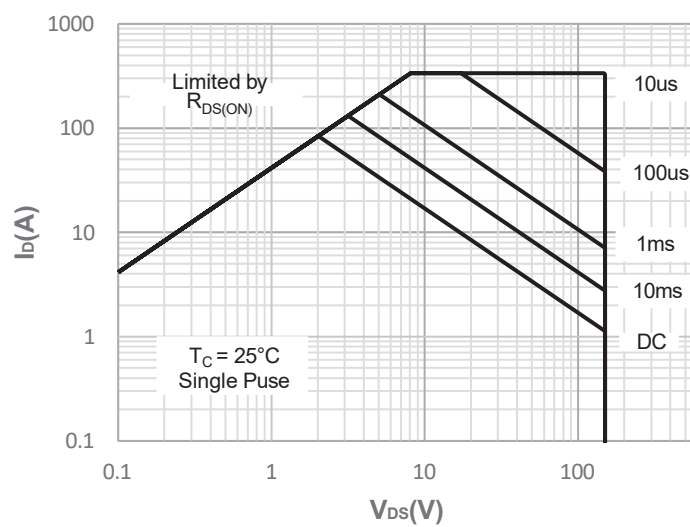


Figure 15: Maximum Safe Operating Area



Test Circuit

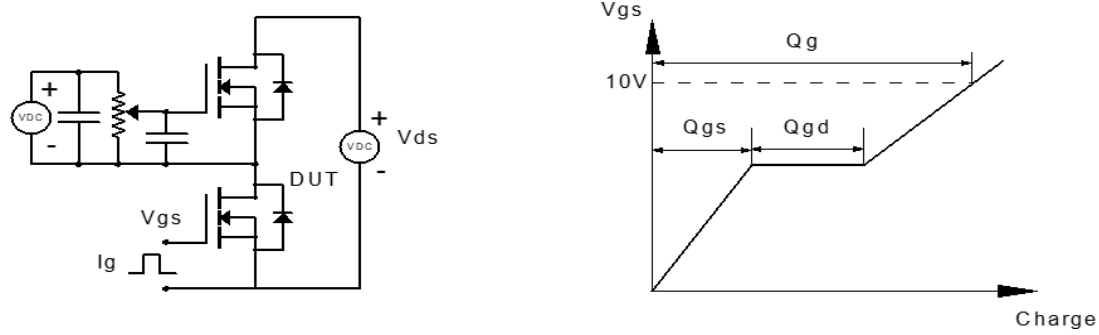


Figure 1: Gate Charge Test Circuit & Waveform

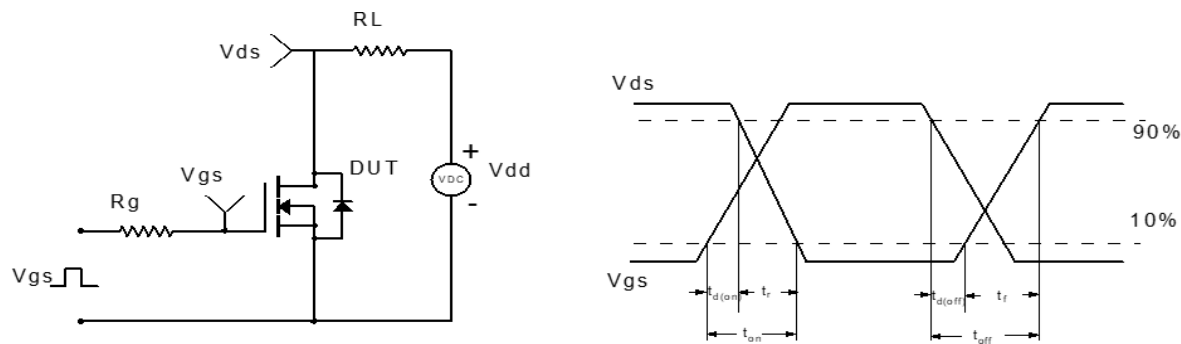


Figure 2: Resistive Switching Test Circuit & Waveform

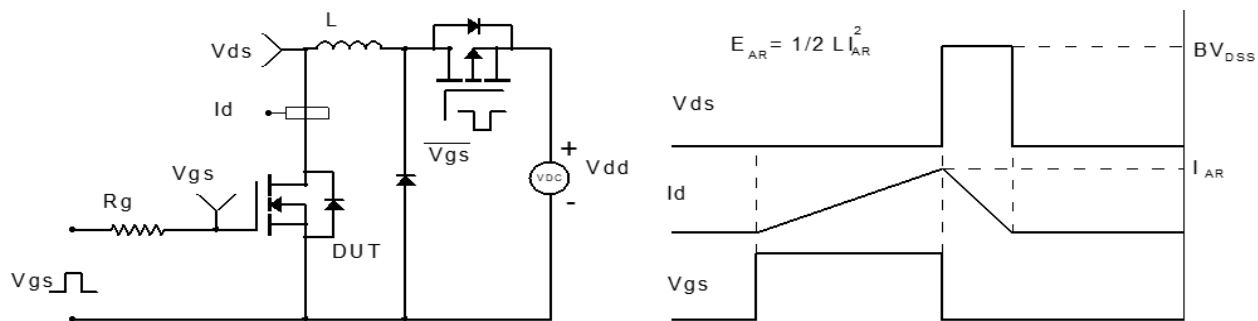


Figure 3: Unclamped Inductive Switching Test Circuit & Waveform

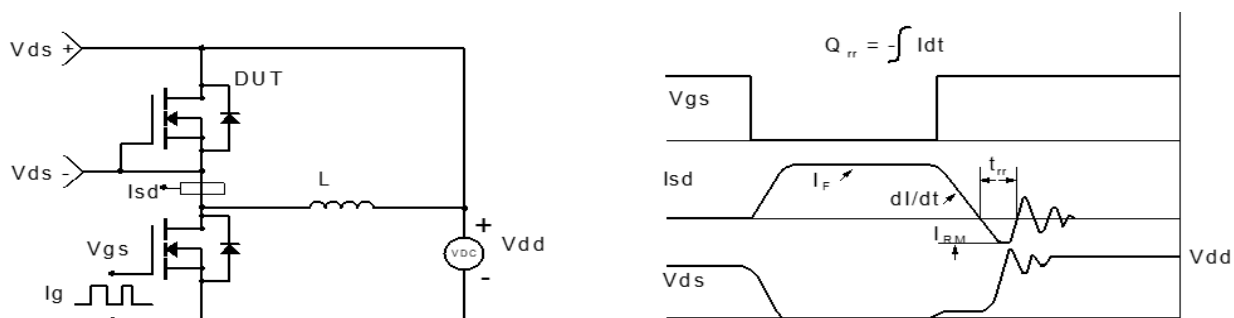


Figure 4: Diode Recovery Test Circuit & Waveform